June 1997



SEMICONDUCTOR TM

NDS336P

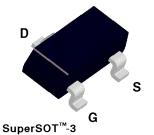
P-Channel Logic Level Enhancement Mode Field Effect Transistor

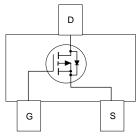
General Description

SuperSOT[™]-3 P-Channel logic level enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage applications such as notebook computer power management, portable electronics, and other battery powered circuits where fast high-side switching, and low in-line power loss are needed in a very small outline surface mount package.

Features

- -1.2 A, -20 V, $R_{DS(ON)} = 0.27 \ \Omega \ @ V_{GS} = -2.7 \ V$ $R_{DS(ON)} = 0.2 \ \Omega \ @ V_{GS} = -4.5 \ V.$
- Very low level gate drive requirements allowing direct operation in 3V circuits. V_{GS(th}) < 1.0V.
- Proprietary package design using copper lead frame for superior thermal and electrical capabilities.
- High density cell design for extremely low R_{DS(ON)}.
- Exceptional on-resistance and maximum DC current capability.
- Compact industry standard SOT-23 surface Mount package.



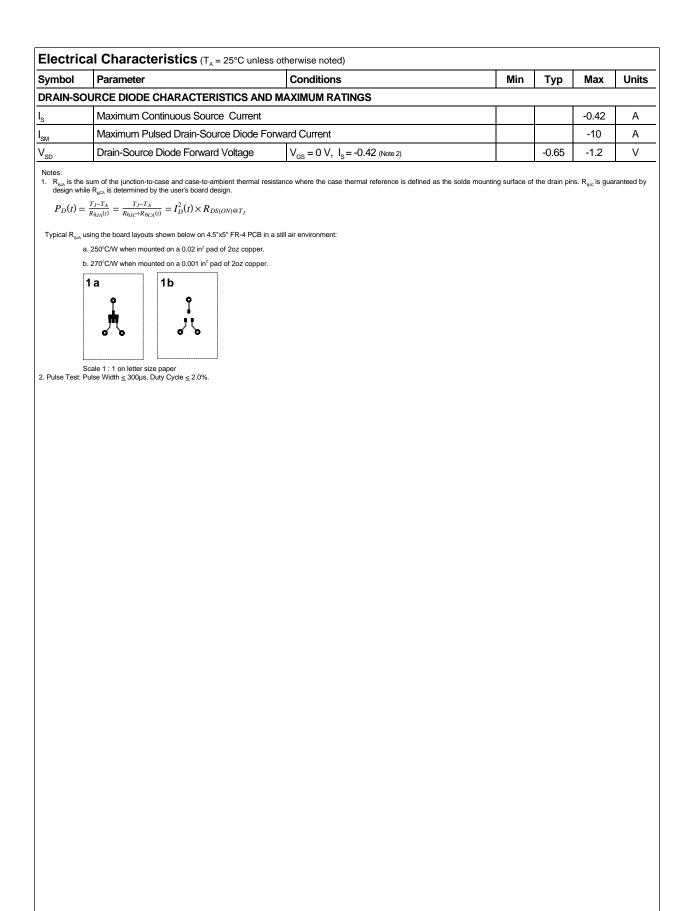


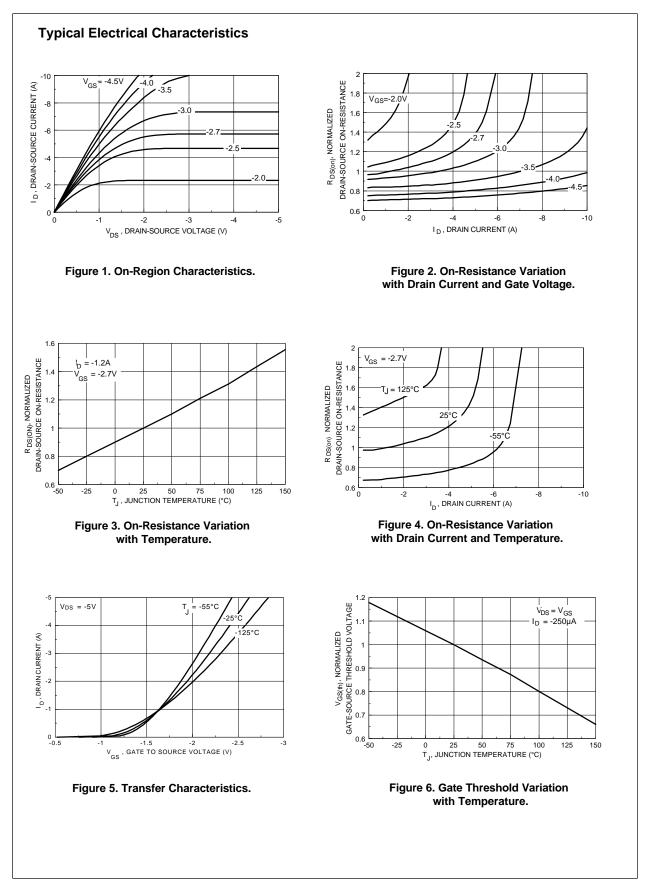
Absolute Maximum Ratings T_a = 25°C unless otherwise noted

Symbol	Parameter		NDS336P	Units
V _{DSS}	Drain-Source Voltage		-20	V
V _{GSS}	Gate-Source Voltage - Continuous		±8	V
I _D	Maximum Drain Current - Continuous	(Note 1a)	-1.2	А
	- Pulsed		-10	
P _D	Maximum Power Dissipation	(Note 1a)	0.5	W
		(Note 1b)	0.46	
T_,T _{stg}	Operating and Storage Temperature Range		-55 to 150	°C
THERMA	L CHARACTERISTICS			
R _{eja}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	250	°C/W
R _{ejc}	Thermal Resistance, Junction-to-Case	(Note 1)	75	°C/W

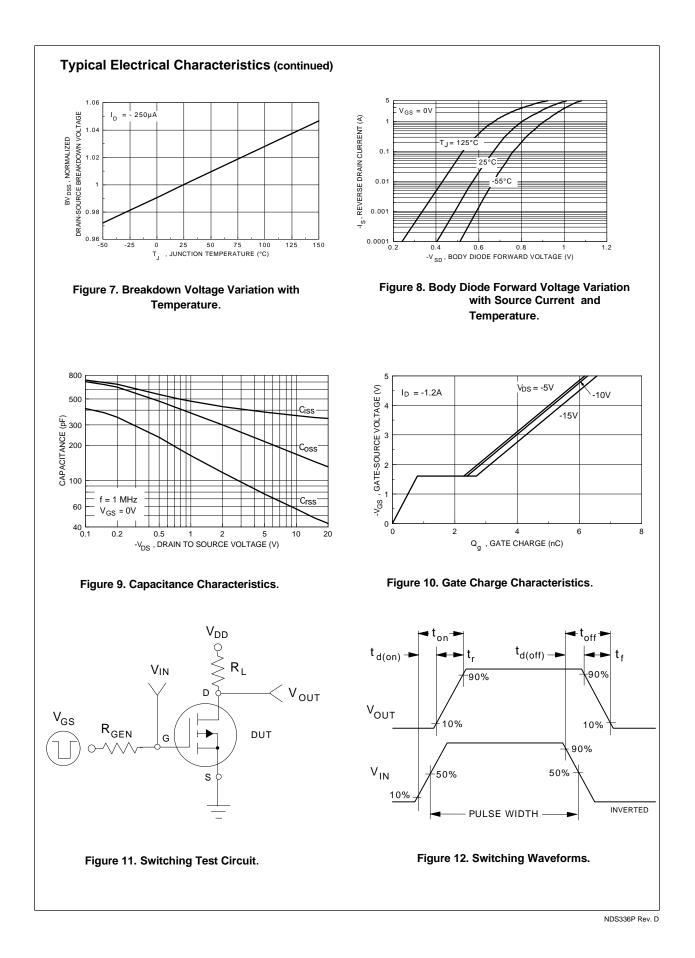
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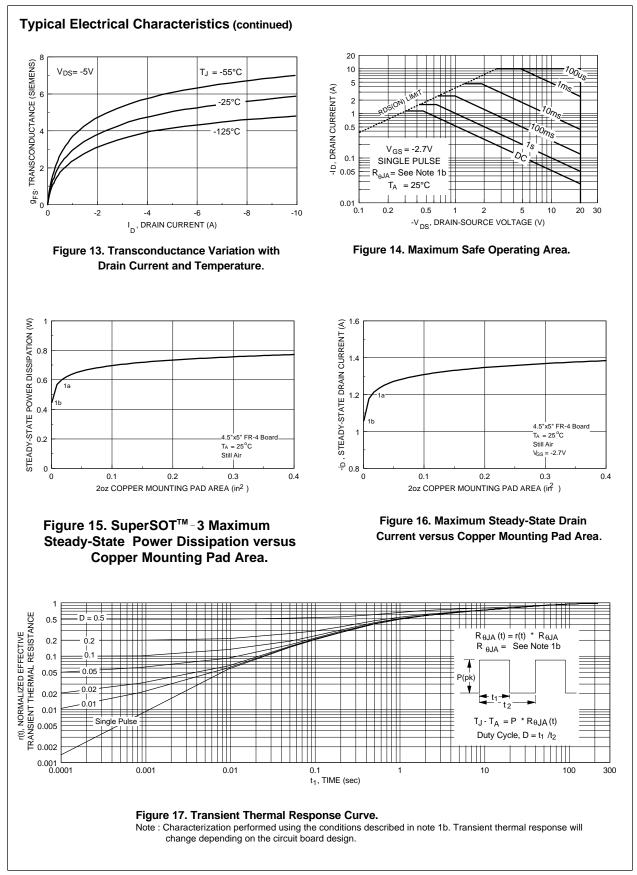
Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHA	RACTERISTICS	·			•		
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = -250 \mu A$		-20			V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -16 V, V_{GS} = 0 V$				-1	μA
			T _J =55°C			-10	μA
I _{GSS}	Gate - Body Leakage Current	$V_{GS} = 8 V, V_{DS} = 0 V$	·			100	nA
I _{GSS}	Gate - Body Leakage Current	$V_{GS} = -8 V, V_{DS} = 0 V$				-100	nA
ON CHAR	ACTERISTICS (Note 2)						
V _{GS(th)}	Gate Threshold Voltage	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = -250 \mu {\rm A}$		-0.5	-0.78	-1	V
			T _J =125°C	-0.3	-0.58	-0.8	
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} = -2.7 V, I _D = -1.2 A	·		0.22	0.27	Ω
()			T_=125°C		0.34	0.49	
		V _{GS} = -4.5 V, I _D = -1.3 A			0.16	0.2	1
I _{D(ON)}	On-State Drain Current	$V_{GS} = -2.7 \text{ V}, V_{DS} = -5 \text{ V}$		-2			Α
9 _{FS}	Forward Transconductance	$V_{DS} = -5 V, I_{D} = -1.2 A$			-3		S
DYNAMIC	CHARACTERISTICS						
C _{iss}	Input Capacitance	$V_{DS} = -10 V, V_{GS} = 0 V,$ f = 1.0 MHz			360		pF
C _{oss}	Output Capacitance				170		pF
C _{rss}	Reverse Transfer Capacitance				60		pF
SWITCHIN	IG CHARACTERISTICS (Note 2)						
t _{D(on)}	Turn - On Delay Time	$V_{DD} = -5 V, I_{D} = -1 A,$			8	15	ns
ţ	Turn - On Rise Time	$V_{\rm GS}=-4.5~V,~R_{\rm GEN}=6~\Omega$			29	50	ns
t _{D(off)}	Turn - Off Delay Time				33	60	ns
t,	Turn - Off Fall Time				23	45	ns
Q _g	Total Gate Charge	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -1.2 \text{ A},$ $V_{GS} = -4.5 \text{ V}$			5.7	8.5	nC
Q _{gs}	Gate-Source Charge				0.7		nC
Q _{gd}	Gate-Drain Charge				1.8		nC





NDS336P Rev. D





NDS336P Rev. D

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